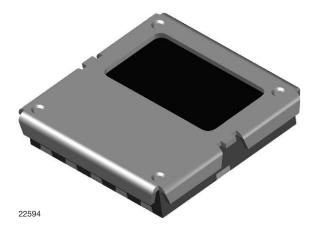
www.vishay.com

Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



LINKS TO ADDITIONAL RESOURCES

	30		
Product Page	3D Models	Calculators	Marking

DESCRIPTION

The TSSP57038H is a compact infrared detector module for presence sensing applications. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

This component has not been qualified according to automotive specifications.

FEATURES

- Up to 2 m for presence sensing
- Uses modulated bursts at 38 kHz
- PIN diode and sensor IC in one package
- Low supply current
- External metal shield
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ORDERING CODE

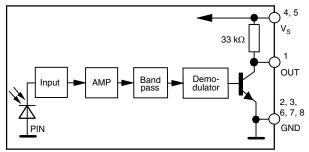
Taping:

TSSP57038HTT1 - top view taped, 1800 pcs/reel

APPLICATIONS

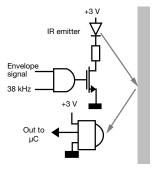
- Reflective sensors for hand dryers, towel or soap dispensers, water faucets, toilet flush
- Vending machine fall detection
- · Security and pet gates
- · Person or object vicinity activation

BLOCK DIAGRAM



20445-7

PRESENCE SENSING







HALOGEN FREE GREEN (5-2008)



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DA	DTC	TA	DI	

PARTS TA	BLE			
Carrier frequency 38 kHz TSSP57038H				
Package		Belobog shield		
Pinning		1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S		
Dimensions (mm)		3.95 W x 3.95 H x 1.0 D		
Mounting		SMD		
Application		Presence sensors		
Special options		Extended temperature range: <u>www.vishay.com/doc?82738</u>		

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6	V
Supply current		I _S	5	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		Ι _Ο	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

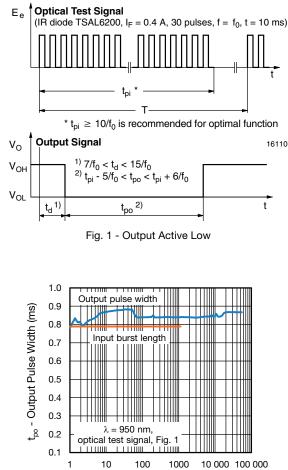
Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Quere hu exercent (cir. Q)	$E_v = 0, V_S = 5 V$	I _{SD}	0.55	0.7	0.9	mA
Supply current (pin 3)	E _v = 40 klx, sunlight	I _{SH}	-	0.8	-	mA
Supply voltage		Vs	2.5	-	5.5	V
Transmission distance	$ E_v = 0, test signal see Fig. 1, \\ IR diode TSAL6200, \\ I_F = 50 mA $	d	-	8	-	m
Output voltage low (pin 1)	$I_{OSL} = 0.5 \text{ mA}, E_e = 2 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	$\begin{array}{c} \mbox{Pulse width tolerance:} \\ t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o, \\ \mbox{test signal see Fig. 1} \end{array}$	E _{e min.}	-	0.7	1.2	mW/m ²
Maximum irradiance	t _{pi} - 5/f _o < t _{po} < t _{pi} + 6/f _o , test signal see Fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	Φ1/2	-	± 75	-	deg



TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)



E_e - Irradiance (mW/m²)

Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

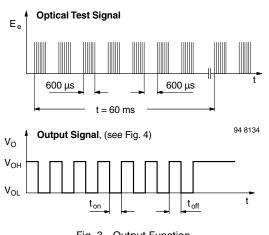


Fig. 3 - Output Function

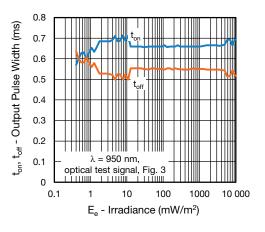


Fig. 4 - Output Pulse Diagram

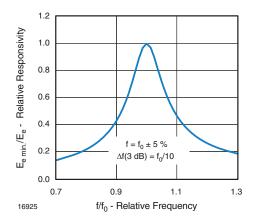


Fig. 5 - Frequency Dependence of Responsivity

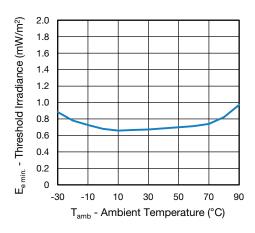
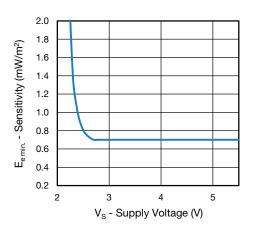


Fig. 6 - Sensitivity vs. Ambient Temperature

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Fig. 7 - Sensitivity vs. Supply Voltage

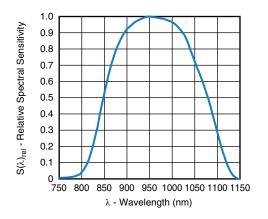


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

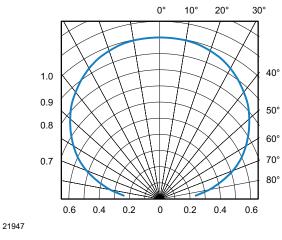
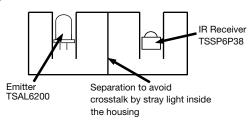


Fig. 9 - Horizontal Directivity

The typical application of this device is a reflective or beam break sensor with active low "detect" or "no detect" information contained in its output. Applications requiring up to 2 m beam break or 1 m reflective range benefit from the lower gain of these sensors because they are less sensitive to stray signal from the emitter, simplifying the mechanical design.

Example for a sensor hardware:



There should be no common window in front of the emitter and detector in order to avoid crosstalk via guided light through the window.

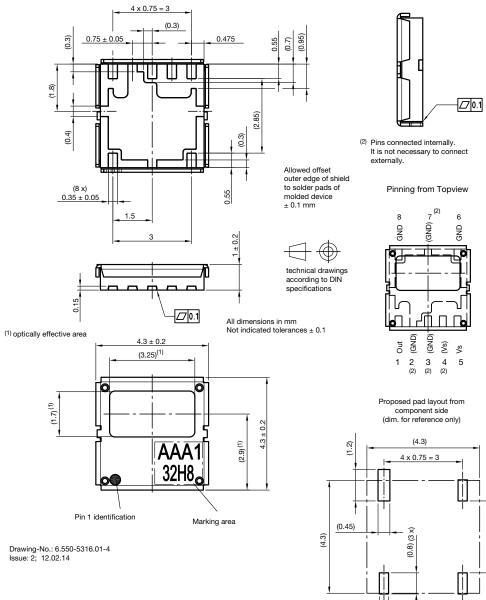
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4





PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- · Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- · Handling after reflow should be done only after the work surface has been cooled off

(2.75)

Manual Soldering

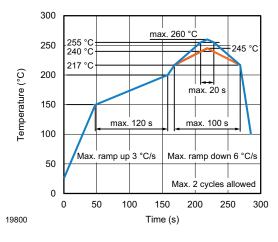
(3 x)(0.35)

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- · Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

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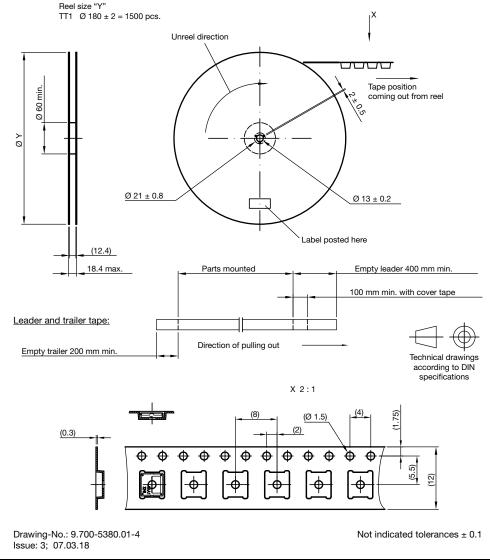


VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSSP57038 DIMENSIONS in millimeters

Tape and reel dimensions:



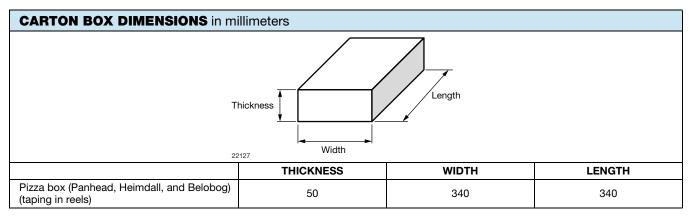
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OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

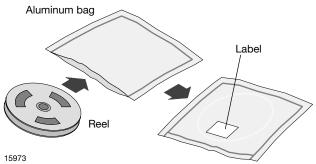
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	X	3
Quantity	Ν	8
Total length	-	21
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH
Selection-code	X	3
Data-code	Ν	3
Batch-number	X	10
Filter	-	1
Total length	-	17

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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 3 label is included on all dry bags.

	Caution LEVEL This bag contains MOISTURE-SENSITIVE DEVICES If the contained with the set of the s
	1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
	2. Peak package body temperature: $\underline{260}$ [fblank, see adjacent bar code label] $^{\circ}C$
	 After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
	a) Mounted within: $\frac{168}{_{If blank, see adjacent bar code label}} hours of factory conditions} \leq 30^\circ C/60\% RH, or$
	b) Stored per J-STD-033
	4. Devices require bake, before mounting, if:
	a) Humidity Indicator Card reads $>10\%$ for level 2a - 5a devices or $>\!60\%$ for level 2 devices when read at $23{\pm}5^\circ C$
	b) 3a or 3b are not met
	5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure
	Bag Seal Date:
	If blank, see adjacent bar code label
22650	Note: Level and body temperature defined by IPC/JEDEC J-STD-020

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

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Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



22178



Vishay

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